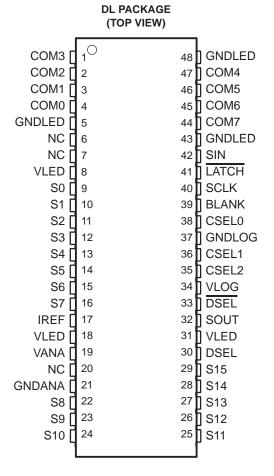
- Drive Capability:
 - Segment . . . 30 mA \times 16 Bits
 - Common . . . 640 mA
- Constant Current Output . . . 3 mA to 30 mA (Current Value Setting for All Channels Using External Resistor)
- Constant Current Accuracy ±6% (Maximum Error Between Bits)
- Data Input: Clock Synchronized Serial Input
- LED Type Applied Cathode Common
- Logic Power Supply Voltage 4.5 V to 5.5 V
- LED Power Supply Voltage 4.5 V to 5.5 V
- Operating Frequency . . . 10 MHz
- Operating Free-Air Temperature Range
 -20°C to 85°C
- 48-Pin SSOL Package

description

The TLC5920 is an LED driver incorporating a 16-channel shift register, data latch, and constant current circuitry with current value control and 8-channel common driver into a single chip. The constant output current is capable of 30 mA for 16 bits simultaneously, and the current value can be set by one external register. This device also includes a 16-bit segment driver and 8-bit common driver; therefore, the monocolor LED array with 16 \times 8 dots can be driven by only one TLC5920, and a two-color LED array with 16 \times 16 dots can be driven by two TLC5920s.

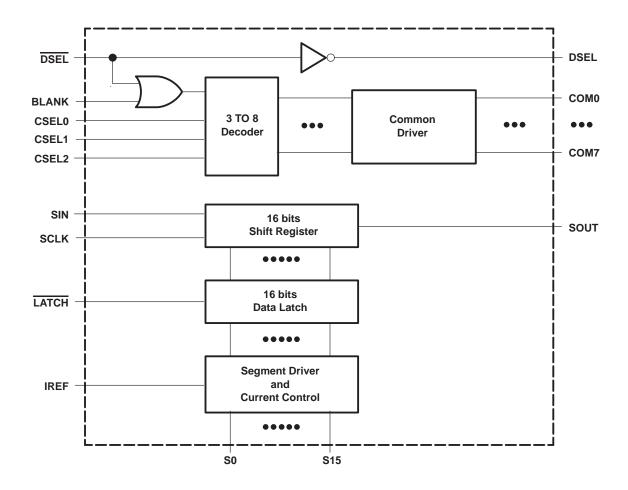




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functional block diagram





Terminal Functions

TERMINAL						
NAME	NO.	I/O	DESCRIPTION			
BLANK	39	I	Blank(light off). By turning all the output for the common driver off, the LED is turned off. When BLANK is high, the LED is turned off.			
COM0 – COM7	4, 3, 2, 1, 47, 46, 45, 44	0	LED common driver output			
CSEL0 – 2	38, 36, 35	I	Common driver select. One terminal out of COM0 through COM7 is selected. 2 1 0 Common Driver L L L 0 L L H 1 L H L 2 L H H 3 H L L 4 H H H 5 H H H 6 H H H 7			
DSEL	33	I	Display select. When DSEL is high, the LED is turned off. Note that, when BLANK is high, the LED is turned off with no regard to the DSEL input.			
DSEL	30	0	Display select output. The inverted data of DSEL is clocked out.			
GNDANA	21		Analog ground			
GNDLED	5, 43, 48		LED driver ground			
GNDLOG	37		Logic ground			
IREF	17	I	Constant current control setting. The LED current is set to the desired value by connecting an external resistor between IREF and GND.			
LATCH	41	I	Latch. When LATCH is high, data on the shift register goes through latch. When LATCH is low, data is latched.			
SIN	42	I	Serial input for display			
SOUT	32	0	Serial output for display			
SCLK	40	I	Synchronous clock input for serial data transfer. The input data of SIN is synchronized to the rising edge of SCLK, and transferred to SOUT.			
S0 – S15	9, 10, 11, 12, 13, 14, 15, 16, 22, 23, 24, 25, 26, 27, 28, 29	0	LED segment driver output			
VANA	19		Analog power supply voltage			
VLOG	34		Logic power supply voltage			
VLED	8, 18, 31		LED driver power supply voltage			



absolute maximum ratings† (see Note 1)

Logic supply voltage, V _(LOG)	
LED supply voltage, V _(LED)	$\ldots \ldots -0.3$ V to 7 V
Analog supply voltage, V _(ANA)	$\ldots \ldots -0.3$ V to 7 V
Output current, I _{OH(S)}	
Output current, I _{OL(C)}	650 mA
Input voltage range, V _I	– 0.3 V to $V_{(LOG)}$ + 0.3 V
Input voltage range, V_1	– 0.3 V to $V_{(LOG)} + 0.3 V$
Continuous total power dissipation	
Thermal resistance	83°C/W
Operating free-air temperature range (see Note 2), T _A	– 20 to 85°C
Storage temperature range, T _{stq}	40°C to 125°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

dc characteristics (see Note 3)

PARAMETER	TEST CONDITIONS	MIN	NOM	MAX	UNIT
Logic supply voltage, V _(LOG)		4.5	5	5.5	V
LED supply voltage, V _(LED)		4.5	5	5.5	V
Analog power supply, V _(ANA)		4.5	5	5.5	V
Voltage between GND and V _(DEF) , G _(DEF)	$G_{(DEF)} = GND_{(LOG)} - GND_{(LED)}$	-0.3	0	0.3	V
High-level input voltage, VIH		2.0		V(LOG)	V
Low-level input voltage, V _{IL}		GND(LOG)		0.8	V
High-level output current, IOH	V _(LOG) = 4.5V, SOUT, DSEL			-1	mA
High-level output current, IOH(S)	S0 to S15			-30	IIIA
Low-level output current, I _{OL}	V _(LOG) = 4.5V, SOUT, DSEL			1.6	mA
Low-level output current, IOL(C)	DUTY = 1/16, COM0 to COM7			640	IIIA
Operating free-air temperature range, T _A (see Note 2)		-20		85	°C

NOTES: 2 $T_J \le 150$ °C (refer to appendix thermal condition).

ac characteristics ($T_A = -20^{\circ}C$ to $85^{\circ}C$)

PARAMETER		TEST CONDITIONS	MIN	NOM	MAX	UNIT
f(SCLK)	Shift clock frequency				10	MHz
tw(H)/tw(I)	SCLK pulse duration (high- or low-level)		40			ns
t _r /t _f	Rise/fall time				100	ns
	Setup time	SIN - SCLK	10			ns
t _{su}		SCLK – LATCH	10			
th	Hold time	LATCH - SCLK	10			ns
		SIN - SCLK	10			113



NOTES: 1. All voltage values are with respect to GND terminal.

^{2.} $T_J \le 150$ °C (refer to appendix thermal condition).

^{3.} VANA must be same as VLED.

electrical characteristics (unless otherwise noted),

MIN/MAX: $V_{(LOG)} = V_{(ANA)} = V_{(LED)} = 4.5 \text{ V}$ to 5.5 V, $T_A = -20^{\circ}\text{C}$ to 85°C TYP: $V_{(LOG)} = V_{(ANA)} = V_{(LED)} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

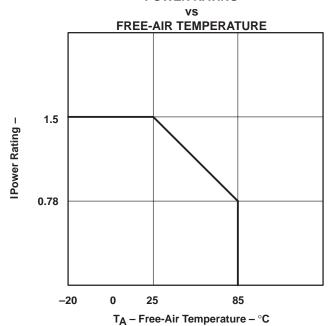
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
Vон	High-level output voltage	$I_{OH} = -1 \text{ mA}, SOUT, DSEL}$	3.6			V		
Voi	Low-level output voltage	I _{OL} = 1.6 mA, SOUT, DSEL			0.6	V		
VOL		I _{OL} = 640 mA, COM0 to COM7		0.6	0.9			
IĮ	Input current	$V_I = V_{(LOG)}$ or $GND_{(LOG)}$			±1	μΑ		
I(LOG)		Data transfer, SCLK = 10 MHz			0.1			
I(LED)	Supply current	LED is turned off		0.8	1.6	mA		
I(ANA)		LED is turned off		0.8	1.6	,]		
IOH(S03)		$V(Sn) = 2.5 \text{ V}, R(IREF) = 4200 \Omega$	-2.45	-3	-3.45	mA		
IOH(S10)	Segment current	$V(Sn) = 2.5 \text{ V}, R(IREF) = 1260 \Omega$	-8.5	-10	-11.5			
I _{OH} (S20)	Segment current	$V_{(Sn)} = 2.5 \text{ V}, R_{(IREF)} = 630 \Omega$	-17	-20	-23	IIIA		
IOH(S30)		$V_{(Sn)} = 2.5 \text{ V}, R_{(IREF)} = 420 \Omega$	-25.5	-30	-34.5			
ΔlOH(S)	Segment current error between bits	$V_{(LED)} = 5 \text{ V}, R_{(IREF)} = 630 \Omega, \\ V_{(Sn)} = 2.5 \text{ V}$		±3%	±6%			
VREF	Voltage reference		1.2	1.26	1.3	V		

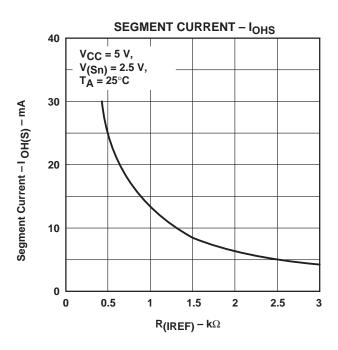
switching characteristics, C_L = 15 pF

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
		SOUT			40	ns	
١.	Rise time	DSEL			40		
t _r		COMn			80		
		Sn			80		
		SOUT			40		
١.,	Fall time	DSEL			40	ns	
t _f	raii time	COMn			40		
		Sn			40		
		LATCH - Sn			40	ns	
١	Propagation delay time	SCLK - Sn			40		
^t d		SCLK - SOUT			40		
		DSEL - DSEL			40		
		CSELn - COMn			120		
^t (DLH)	Propagation delay time	DSEL - COMn			120	ns	
		BLANK - COMn			120		
		CSELn - COMn			40		
t(DHL)	Propagation delay time	DSEL - COMn			40	ns	
		BLANK - COMn			40		

PARAMETER MEASUREMENT INFORMATION

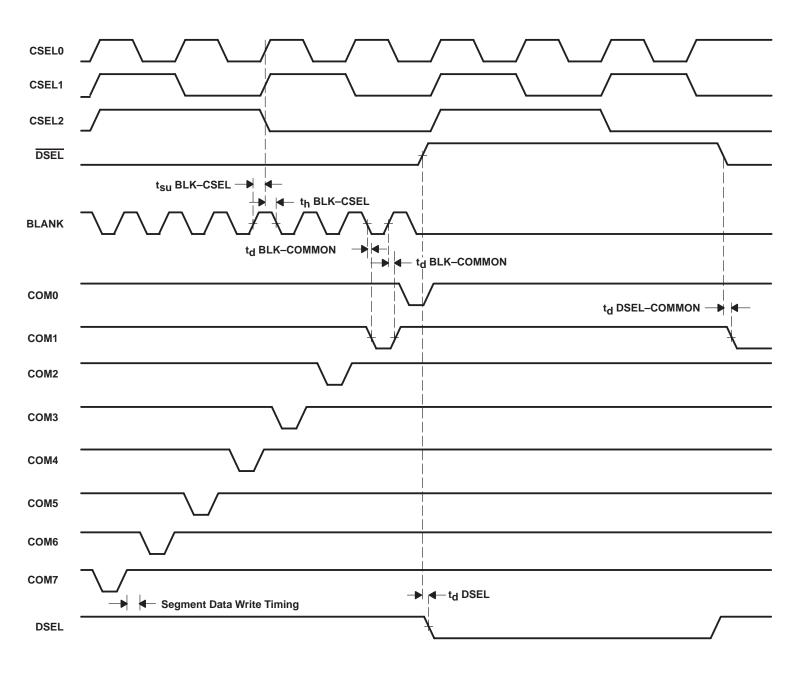
POWER RATING



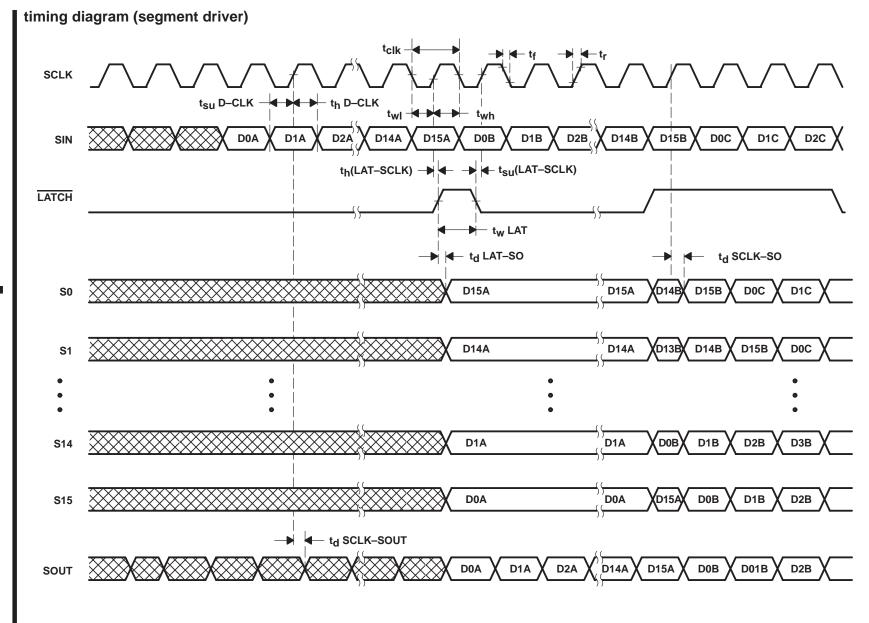


$$I_{\mbox{OH(S)}} = \frac{V_{\mbox{REF}}}{R_{\mbox{(IREF)}}} \times 10$$

timing diagram (common driver)



Release Date: 7-11-94



APPLICATION INFORMATION

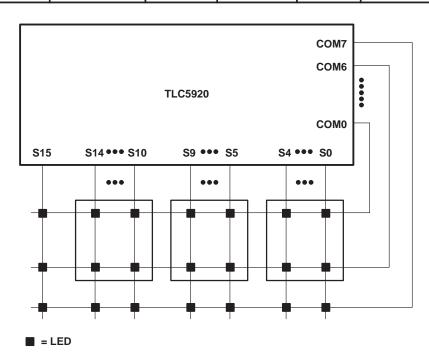
example 1

The other remaining terminals used for dot matrix LED drive can be utilized for LED lamp drive and other displays.

LEDs driven by TLC5920

cathode common type

	LED		TLC5920	DUTY	DRIVE CURRENT	
TYPE	NO. OF COLOR	QUANTITY	QUANTITY	ווטע	(mA)	
LAMP	Mono	16	1	Static	30	
LAIVIP	Two	8	1	Static	30	
7 SEGMENT	Mono	16	1	1/8	30	
/ SEGIVIEIVI	Two	8	1	1/8	30	
5 x 7	Mono	3	1	1/8	30	
5 X 7	Two	1	1	1/8	30	
8 x 8	Mono	2	1	1/8	30	
0 X 0	Two	1	1	1/8	30	
	Mono	2	2	1/16	20	
16 x 16	Two	1	2	1/16	20	
	Three	1	3	1/16	13	
24 x 24	Mono	2	3	1/24	13	
	Two	1	3	1/24	13	

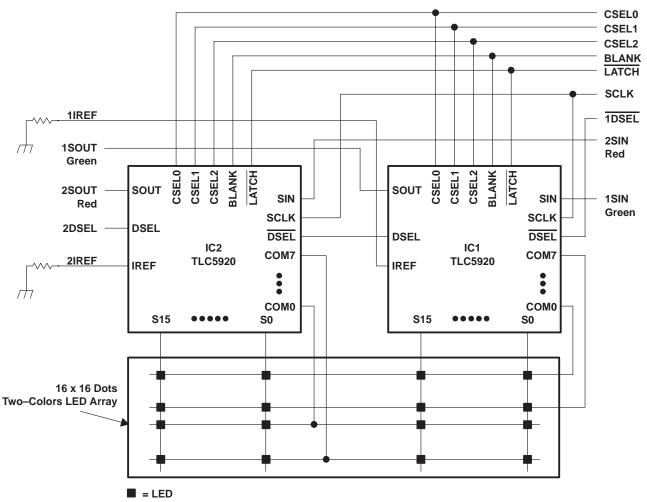




APPLICATION INFORMATION

example 2

Using two TLC5920s, an LED with two colors and 16 x 16 dots can be driven. The number of LED arrays can also be increased by making a cascade connection in the application circuit.



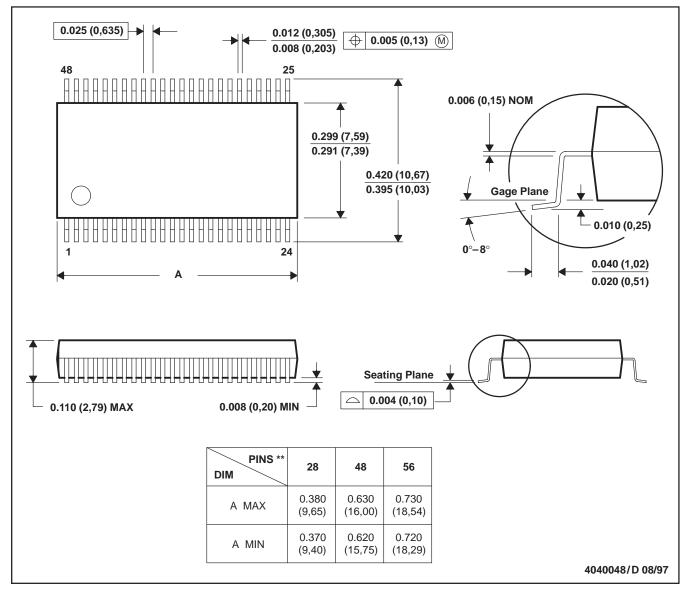


MECHANICAL DATA

DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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